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# SH7764 Group

## SH7764 Example of Initial Setting

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### Introduction

This application note gives an example of configuration items to activate the SH7764 Microcomputers.

### Target Device

SH7764 (R0K507764E001BR from Renesas Technology Corp.)

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## 1. Preface

### 1.1 Specifications

Configure the memory controller unit (MCU), general purpose I/O (GPIO), and cache after the power-on reset is canceled.

### 1.2 Module Used

- Memory controller unit (MCU)
- Cache

### 1.3 Applicable Conditions

- MCU SH7764
- Operating frequency CPU clock: 324 MHz  
SuperHyway clock: 108 MHz  
Peripheral clock: 54 MHz  
Bus clock: 108 MHz
- Bus width for area 0 32 bits (MODE3 pin = High, MODE4 pin = High)
- Clock operating mode Mode 3 (MODE2 = Low, MODE1 = High, MODE0 = High)
- Data alignment Little endian
- Address mode 29-bit
- C compiler SuperH RISC Engine Family C/C++ Compiler Package Ver.9.03 Release00 from Renesas Technology Corp.

The locations of the sections for this sample application are described in table 1.

**Table 1 Section Locations**

Section	Used As	Area	Address (Virtual Address)	
P	Program area (default)	ROM	0x00003000	P0 area (cacheable area with translatable MMU addresses)
C	Constant area	ROM		
C\$BSEC	Address structure for non-initialized data areas	ROM		
C\$DSEC	Address structure for initialized data areas	ROM		
D	Initialized data (initial value)	ROM		
B	Non-initialized data area	RAM	0x04000000	
R	Initialized data area	RAM		
S	Stack area	RAM	0x07FFF9F0	
INTHandler	Exception/interrupt handler	ROM	0x80000400	P1 area (cacheable area with untranslatable MMU addresses)
VECTTBL	Reset vector table or interrupt vector table	ROM		
INTTBL	Interrupt mask table	ROM		
P_IntPRG	Interrupt function	ROM		
SP_S	Stack area for the TLB-miss handler	RAM	0x87FFDF0	
RSTHandler	Reset handler	ROM	0xA0000000	P2 area (uncacheable area with untranslatable MMU addresses)
P_ResetPRG	Initialized program area	ROM	0xA0002000	

## 2. Description of the Sample Application

This application note describes the SDRAM interface and an example of a program for making the initial settings.

Execution of the sample program described in this application note is a precondition for the sample programs described in other application notes for the SH7764.

### 2.1 Description of the SDRAM Interface

#### 2.1.1 Overview

The SH7764 MCU memory controller unit includes the SDRAM interface to connect with the SDRAM directly.

Since SDRAMs can be selected by the CS signals, they can be connected to physical areas 1 and 2 while sharing the control signals such as  $\overline{\text{RAS}}$ .

The control signals used for direct connection with SDRAM are:  $\overline{\text{RAS}}$ ,  $\overline{\text{CAS}}$ ,  $\text{R}/\overline{\text{W}}$ ,  $\overline{\text{CS1}}$  or  $\overline{\text{CS2}}$ ,  $\text{DQMLL}$ ,  $\text{DQMLU}$ ,  $\text{DQMUL}$ ,  $\text{DQMUU}$ ,  $\overline{\text{WE0}}$  to  $\overline{\text{WE3}}$  (for 64-bit bus) and  $\text{CKE}$ . All these signals except  $\overline{\text{CS1}}$  and  $\overline{\text{CS2}}$  are common to each section, and those except  $\text{CKE}$  are enabled and latched only when  $\overline{\text{CS1}}$  or  $\overline{\text{CS2}}$  is asserted.

This module supports burst read/write mode as the SDRAM operating mode. Data bus width can be 32 or 64 bits depending on the BW bit settings in the MIM register.

#### 2.1.2 SDRAM Specifications

Table 2 lists the specification of the SDRAM to use in this application. The specifications of the SDRAM used for this application note (EDS2516AFTA-75-E, manufactured by Elpida Memory, Inc.) are listed in the table below. As detailed specifications differ with the device, be sure to check the data sheet for the product you will be using.

**Table 2 SDRAM Specifications**

Item	Specification
Clock frequency	133 MHz (at maximum)
Density	256 Mbits (32 MB): 2
Configuration	4 banks × 16 M words × 16 bits
CAS latency	2, 3 (programmable)
Refresh	8,192 refresh cycles every 64 ms
Burst length	1, 2, 4, 8, or full page (programmable)
Row address	A12 to A0
Column address	A8 to A0

2.1.3 Memory Map

Connect the SH7764 CS1 or CS2 spaces to SDRAM. Cache is enabled or disabled by the top 3 bits of the internal address (when the MMU is on). This application allocates the SDRAM in CS1 space. Figure 1 shows the memory map.

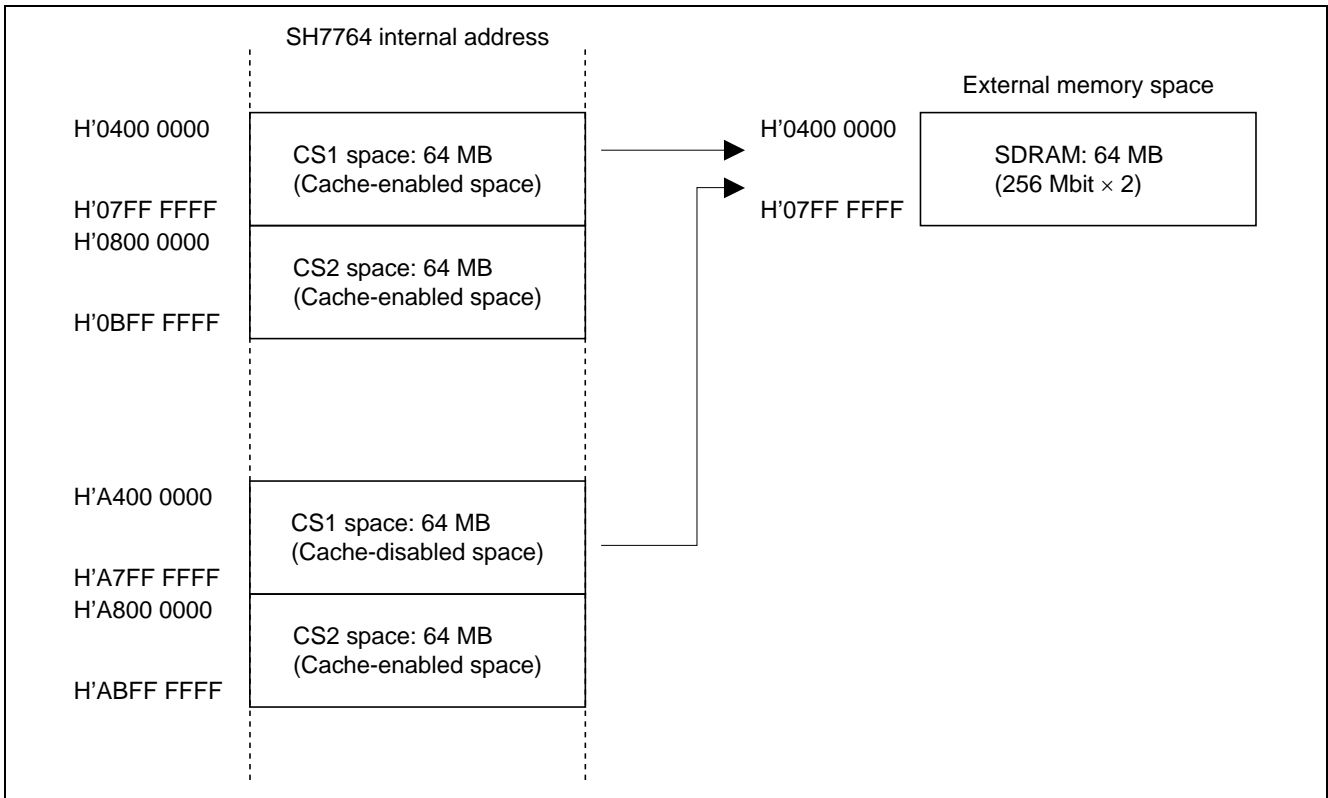


Figure 1 Memory Map Associated with the SDRAM

2.1.4 SDRAM Connection Circuit Example

Figure 2 shows the SDRAM connection circuit example.

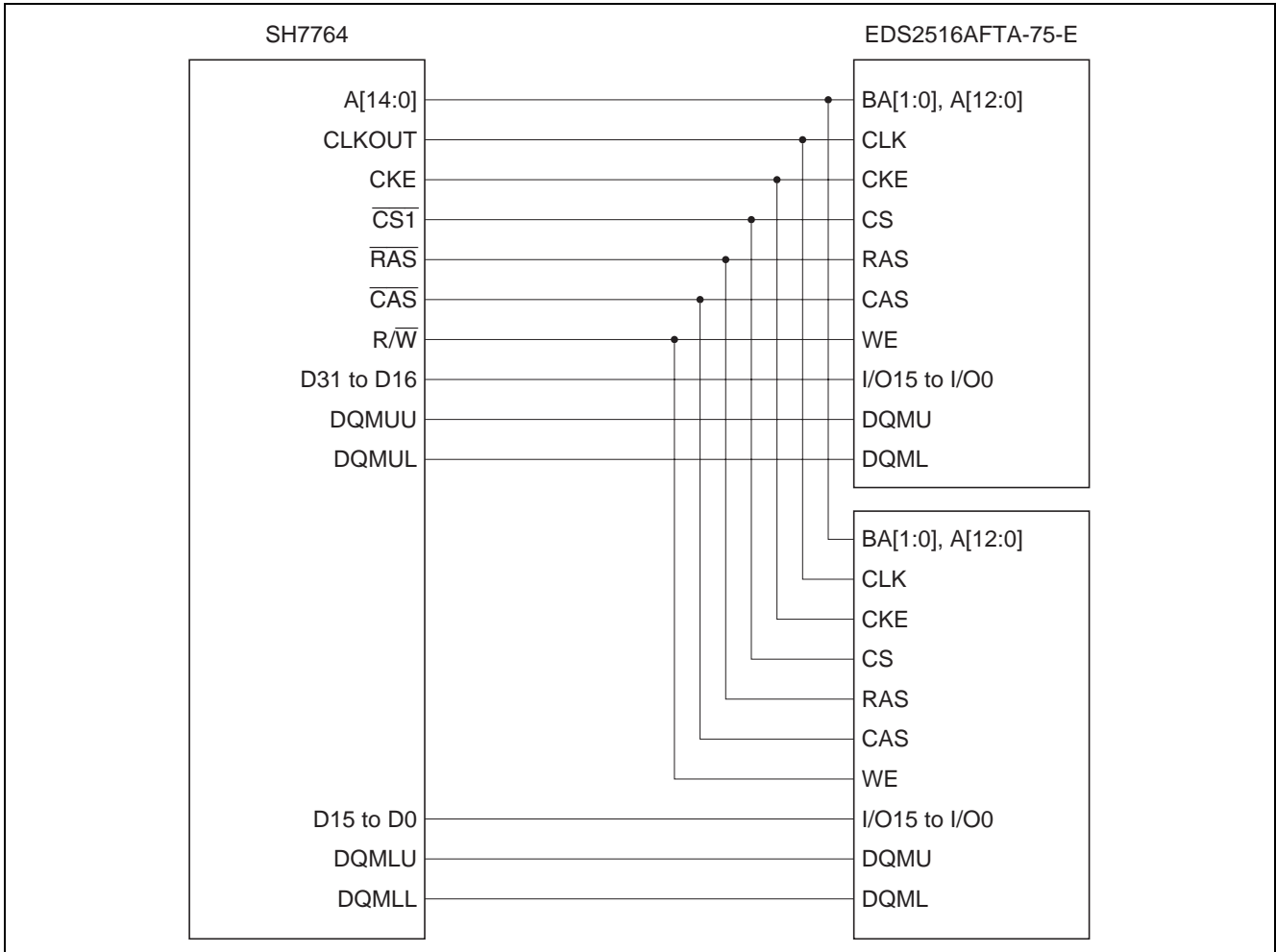


Figure 2 SDRAM Connection Circuit Example (256 Mbit x 2, 32-bit bus)

2.1.5 Address Multiplex Output

Table 3 lists the address-multiplexed output pins used in the sample application.

Note that the SH7764 is not designed to handle row/column configurations other than those listed below.

- 12 x 9 (= 8 M x 16 bits or 8 M x 32 bits)
- 13 x 9 (= 16 M x 16 bits)

Table 3 Address Multiplex Output

External Bus	SDRAM Address	BA1	BA0	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0
32 bits	SH7764 Address	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0
256 Mbits	Bank (2)	12	13													
(32 MB)	Row (13)			11	25	24	23	22	21	20	19	18	17	16	15	14
16 M x 16	Col (9)							10	9	8	7	6	5	4	3	2

**2.1.6 Power-on Sequence**

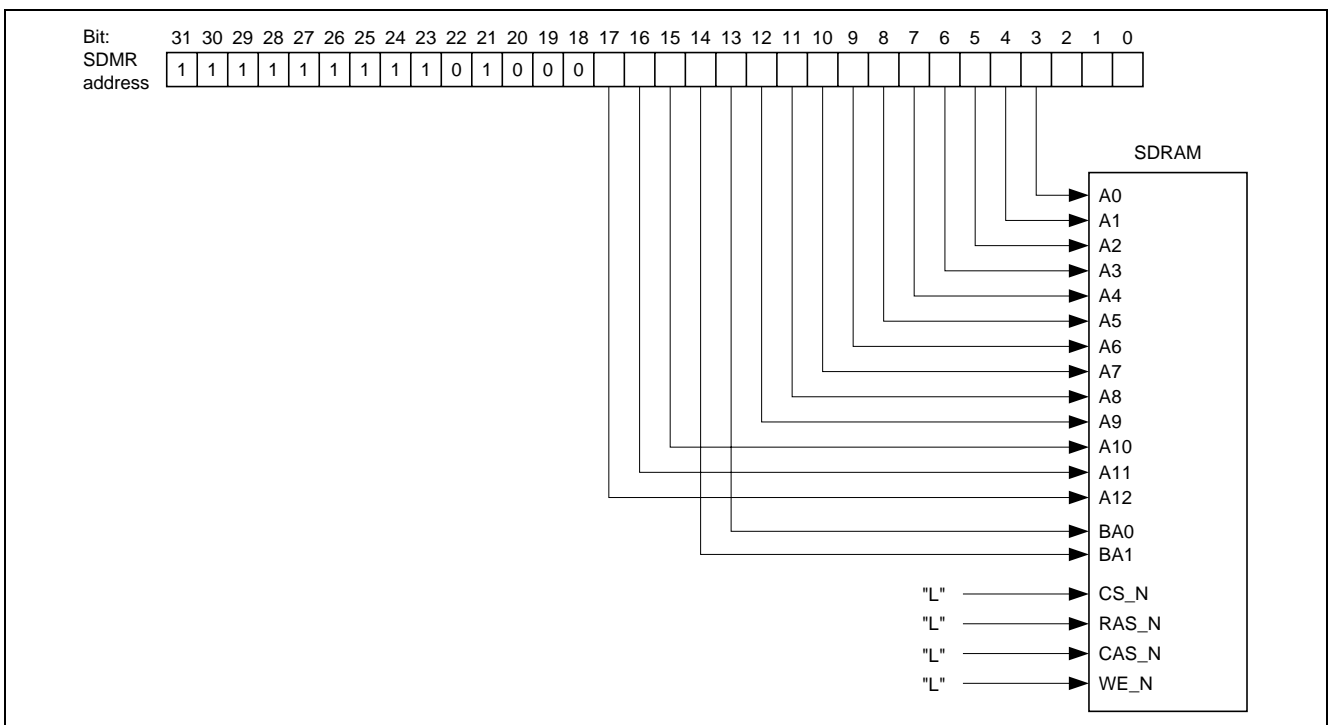
To initialize the SDRAM, write the data in the SDRAM mode register after setting the MCU (memory controller unit) register. As the SDRAM requires a certain period of idle cycles, check the specifications of the SDRAM you use, and set the SDRAM mode register after the specified period of idle cycles is elapsed.

Use the arbitrary data in the access address to write in long words (32-bit) in the SDRAM mode register. Specify the access address according to the setting. When writing data in the access address in long words, the MCU provides the set value in the SDRAM mode register.

When other settings than the below are made, correct operation is not guaranteed.

- BL = 4 (When external bus is 64 bits wide) or 8 (When external bus is 32 bits wide)
- BT = Sequential
- LMODE (CL) = 2 or 3
- OPCODE = Burst read & burst write

Figure 3 shows the connection example of the mode register and SDRAM.



**Figure 3 Connection Example of the Mode Register and SDRAM**



2.1.7 SDRAM Initialization Procedure (Example)

Figure 4 shows an example of the SDRAM initialization procedure.

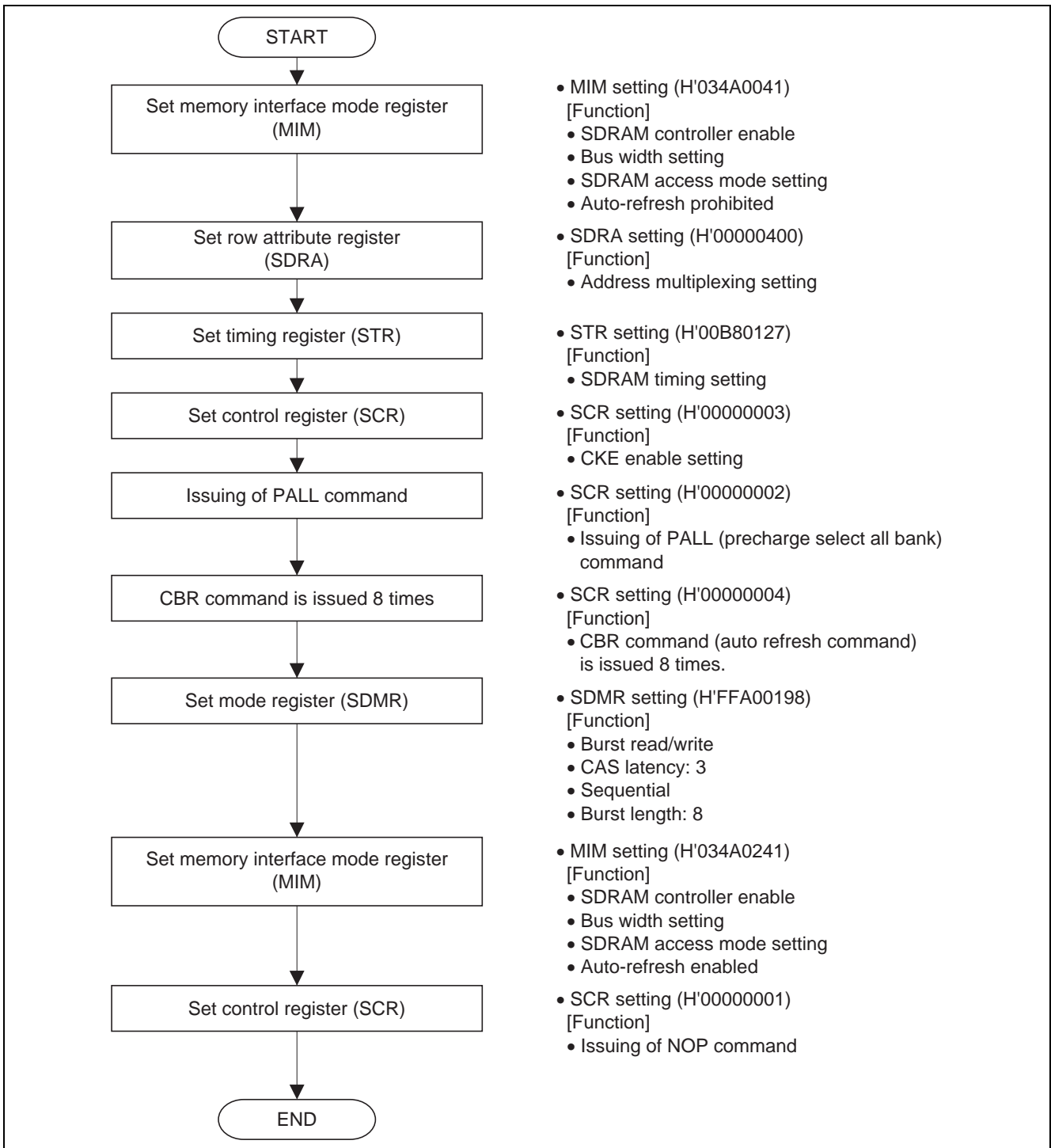


Figure 4 Example of the SDRAM Initialization Procedure

## 2.2 Description of the Sample Programs

This initialization program consists of the following nine source files:

- (1) vhandler.src
- (2) vecttbl.src
- (3) resetprg.c
- (4) hwsetup.c
- (5) stacksct.h
- (6) dbsct.c
- (7) main.c
- (8) intprg.c
- (9) vect.inc

### (1) vhandler.src

When an exception (reset, general exception, or interrupt) occurs, the code in the exception handler (vhandler.src) is first to be executed. File vhandler.src contains the code for processing by the handlers for all exceptions and the processing for MCU initialization. Processing in handlers for the reset and for exceptions other than reset is different; for details, see *SuperH RISC engine C/C++ Compiler Package Application Note: [Introduction Guide] Sample FileGuide for SH-3, SH-4, and SH-4A* (REJ06J0012).

If the MMU is to be used, TLB misses must also be taken into consideration. If the stack area is allocated to the P0 or P3 area where address translation by the TLB is enabled, generation of a TLB-miss exception will lead to a further TLB-miss exception every time the TLB-miss handler places a value on the stack, leading to the generation of a manual reset.

A stack area (H'200) for exclusive use in cases where a TLB miss occurs is set up in area P1 where address translation by the TLB is disabled. The TLB-miss handler in this sample program uses the stack area (H'200) for exclusive use until return from the TLB-miss handler. The reset handler (from label `_Reset_handler`) is activated by a power-on reset. In an event handler processing, a common vector table (`_INT_Vectors`) for exception handling (resets, general exceptions, and interrupts) is looked up, and the general exception function or interrupt function is determined in accord with the value in the exception event register (EXPEVT) or the interrupt event register (INTEVT), respectively. In an exception handler processing, the BL bit is cleared so that multiple interrupts can be handled before any handler processing of exceptions.

Accordingly, a nonmaskable interrupt (NMI) will be accepted even if a previous NMI is being processed. As a countermeasure against this, processing to clear the BL bit is not executed when the exception code corresponds to the NMI.

### (2) vecttbl.src

This file contains definitions for the vector table for exception handling (resets, general exceptions, interrupts) and interrupt mask table. The tables are looked up in processing by the code in vhandler.src (described above), and processing continues in the corresponding exception handling function (resetprg.c or intprg.c).

### (3) resetprg.c

This file contains the code for the `PowerON_Reset()` function, i.e. the reset processing program. The `PowerON_Reset()` function contains code that sets the vector base register (VBR), sets the FPSCR, calls the `_INITSCT()` function, calls the `HardwareSetup()` function, sets the RAMCD, sets the status register (SR), and calls the main function.

The initial setting of FPSCR selects 32 bits as the transfer size for floating-point instructions. Please change this setting if this is required by the specifications of your application.

The RMD (on-chip memory access mode) bit in the on-chip memory control register (RAMCR) is set to 1, enabling access to on-chip memory in user mode.

The reset vector address is fixed at H'A000 0000. Start addresses for general exceptions and interrupts other than the reset are determined by adding an offset (H'400 for TLB miss exceptions, H'100 for other exceptions in general, and H'600 for interrupts) for the specific event to the vector base address.

In the sample program, the start address of the general exception handler (`_INTHandlerPRG`) is exported by the exception handler (vhandler.src) and then used to set the VBR in the `PowerON_Reset()` function, the first to be called in the reset processing program (resetprg.c).

In the exception handler (vhandler.src), the start addresses of the TLB miss handler (\_TLBmissHandler) and interrupt handler (\_IRQ\_Handler) are defined by ".org H'300" and ".org H'500", respectively based on the offset (H'100) for other exceptions in general.

If the sample program is extended to include settings for the internal registers of peripheral modules, the main function is intended to be the source of calls to the corresponding functions. Therefore the status register (SR) is set in privileged mode in the PowerON\_Reset() function. If peripheral modules are to be used in user mode, be sure to exclude instructions which are only available in privileged mode.

(4) hwsetup.c

This file is used to set up peripheral module operations. In the sample program, the settings are for the cache. The program enables the instruction cache and operand cache, and selects the copy-back mode. Moreover, although they are not used in the program, GPIO settings for the R0K507764E001BR are included for reference.

(5) stacksct.h

stacksct.h specifies the size of the stack area (the initial value is H'400). When changing the size of the stack area is to be changed, avoid doing so by directly changing this file (to change the address and the size of the stack area, click on Project (P) in the menu bar of the High-performance Embedded Workshop, click on the Edit Configuration (E) item and then select the tab for stack settings)

(6) dbstc.c

initialization of sections: specifically, definition of the addresses where the initialized data sections (sections D and R) and non-initialized data section (section B) start and end. Clearing of section B to 0 and copying of data from section D to section R are handled by the call of the \_INITSCT() function from within the PowerOn\_Reset() function, which is in resetprg.c.

(7) main.c

main.c is the main function which is called on completion of initialization. User programs should be written within the main routine.

(8) intrpg.c

The programs (dummy functions) in this file are called by the handler (vhandler.src) for general exceptions and interrupts other than resets. When interrupts for peripheral functions are used, alter the dummy function by creating new functions on the basis of this sample program (and altering vect.inc and vecttbl.src in accord with any changes of function name), or include a call to a separate function within the dummy function.

Processing for tasks such as clearing interrupt request flags should be written in accord with the descriptions in the *SH7764 Group Hardware Manual* (REJ09B0360).

(9) vect.inc

To enable reference from vhandler.src to the individual processing routines for general exceptions and interrupts in intrpg.c, declarations of symbols for external reference are made in vect.inc. When a dummy function of intrpg.c is rewritten as a new interrupt function, change the function name in the corresponding entry of this file accordingly. If separate functions are called from within the dummy function, changes to this file are not necessary.

Figure 5 shows the flow of processing from a power-on reset.

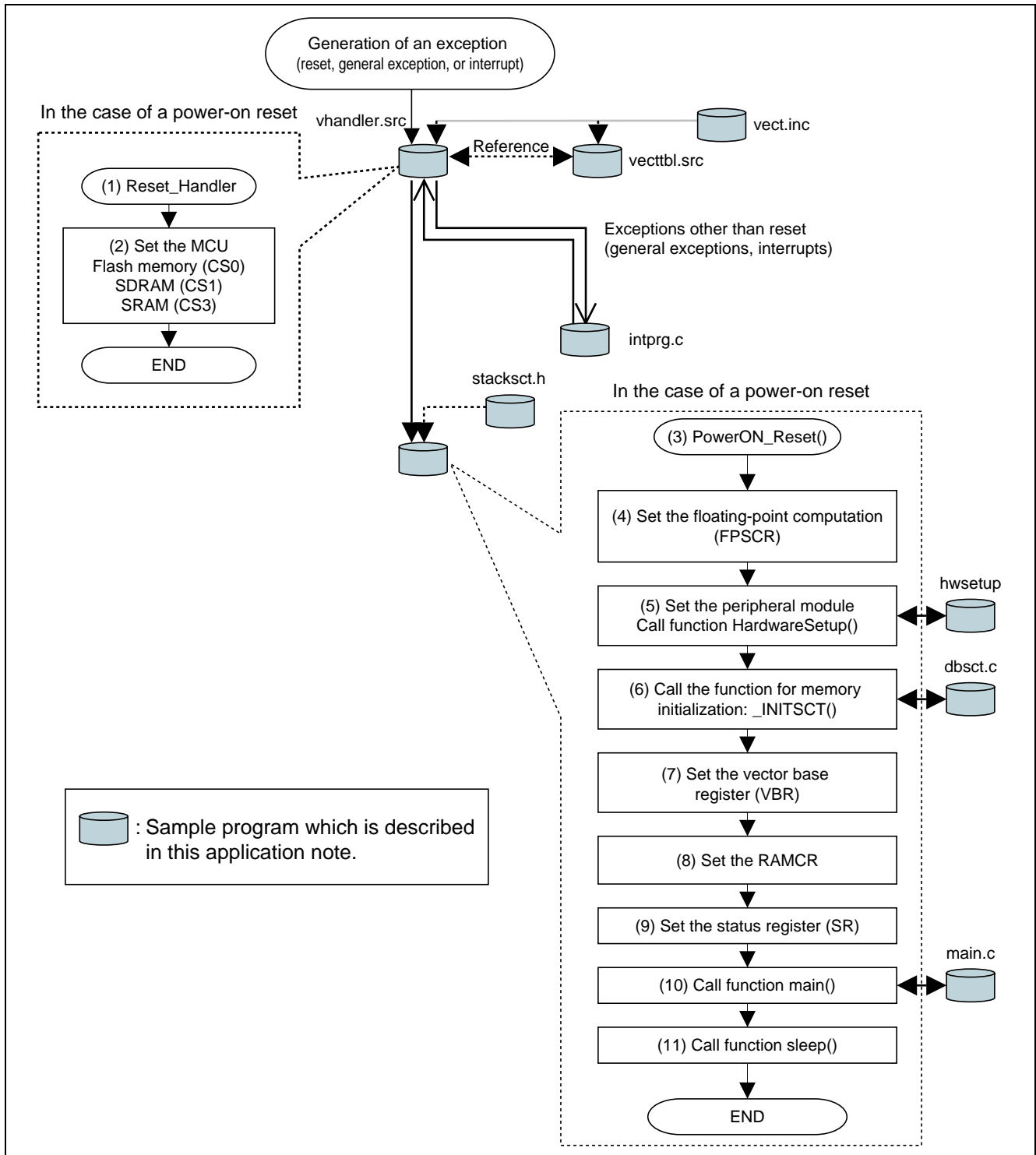


Figure 5 Flow of Processing from Power-On Reset

### 2.2.1 Example of Settings in the Sample Program

Table 4 is a list of the settings in the sample program.

**Table 4 Settings in the Sample Program**

Module	Description
MCU	<p>CS0 NOR-type flash memory Data bus width: 32-bit Idle cycles between read and write access cycles to different areas: 3 Idle cycles between read and write access cycles to same area (area 0): 3 Idle cycles between read and read access cycles to different areas: 3 Idle cycles between read and read access cycles to same area (area 0): 3 Address hold cycles: 1 Specify the number of wait cycles to be inserted during an access to the CSn space: 11</p> <p>CS1 SDRAM Access mode: BANK open mode Refresh interval: 546 counts Refresh mode: Auto-refresh Little endian Data bus width: 32-bit Enables SDRAM control Minimum number of cycles for transition from write to read: 9 Minimum number of cycles for transition from read to write: 12 Number of PRE/PALL command issue cycles (Twr): 2 Number of auto-refresh-ACT/auto-refresh issue cycles (Trfc): 8 Minimum number of ACT-PRE command issue cycles (Tras): 7 Number of PRE-ACT command issue cycles (Trp): 3 Number of ACT-auto-refresh/ACT-ACT command issue cycles (Trc): 9 CAS latency: 3 cycles Number of RAS-CAS command issue cycles (Trcd): 3 SDRAM memory configuration specification bit: Row 13 bits × Column 9 bits (16 M × 16 bits product)</p> <p>CS3 SRAM Data bus width: 32-bit Idle cycles between write and read/write and write access cycles: 4 Idle cycles between read and write access cycles to different areas: 2 Idle cycles between read and write access cycles to same area: 4 Idle cycles between read and read access cycles to different areas: 2 Idle cycles between read and read access cycles to same area: 2 Address hold cycles: 2 Specify the number of wait cycles to be inserted during an access to the CSn space: 8</p>
Cache	<p>Instruction/operand cache enabled P1 area: Copyback mode P0, U0 and P3 areas: Copyback mode</p>

### 2.2.2 Precautions in Using the Sample Programs

- To permit allocation of the B, R and S sections to external memory and initialization, this program initializes the memory controller unit (MCU) and SDRAM interface before section initialization. Thus, a function to be executed before section initialization (\_INITSCT function execution) should not use global variables which are placed in a section to be initialized by the \_INITSCT function.
- This program writes data from the operand cache back to the B and R sections (by using the OCBP instruction for writeback and invalidation) to transfer the cache contents to the external memory. To execute a program in RAM by using the ROM support function, copy the section by using the \_INITSCT function. Cached data must then be written back in the same way as for the B section, etc.
- The stack pointer address set at the beginning of the Entry function (PowerON\_Reset function) is the address specified in project generation by the High-performance Embedded Workshop. To change the address and size of the stack area, click on Project (P) in the menu bar for the High-performance Embedded Workshop, click on the Edit Configuration (E) item and then select the tab for the stack (do not directly change the address of the S section directly as doing so might prevent starting of the dialog dialogue box by clicking on Edit Configuration (E)).

### 3. Listings of Sample Program Files

#### 3.1 Sample Program "vhandler.src"

```

1  ;/*"FILE COMMENT"*****
2  ;*      System Name :   SH7764 Sample Program
3  ;*      File Name   :   vhandler.src
4  ;*      Version    :   1.00.00
5  ;*      Contents   :   SH7764 Intialize Program
6  ;*      Model      :   Renesas SH7764 Board R0K507764E001BR
7  ;*      CPU        :   SH7764
8  ;*      Compiler   :   SHC.9.03.00
9  ;*      OS         :   none
10 ;*
11 ;*      note       :   < Caution >
12 ;*                This sample program is provided simply as a reference and
13 ;*                its operation is not guaranteed.
14 ;*                Use this sample program as a technical reference when
15 ;*                developing software.
16 ;*
17 ;*                Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 ;*
19 ;*      History    :   2009/03/01 ver 1.00.00
20 ;*
21 ;*****/
22             .include      "vect.inc"
23
24             .import      _INT_VECTORS
25             .import      _RESET_VECTORS
26             .import      _INT_MASK
27
28 EXPEVT      .equ         H'FF000024
29 INTEVT      .equ         H'FF000028
30
31 IMASKclr:    .equ         H'FFFFFF0F
32 RBBLclr:    .equ         H'FFFFFF
33 MDRBBLset   .equ         H'70000000
34 MDRBset     .equ         H'60000000
35 RBclr:      .equ         H'DFFFFFFF
36
37 ;;;;;;;;;;;;;;
38 ;                MACRO DEFINITON
39 ;;;;;;;;;;;;;;
40
41             .macro PUSH_EXP_BASE_REG
42                 STC.L     SSR,@-R15
43                 STC.L     SPC,@-R15
44                 STS.L     PR,@-R15
45                 STS.L     FPSCR,@-R15
46                 STC.L     R7_BANK,@-R15
47                 STC.L     R6_BANK,@-R15
48                 STC.L     R5_BANK,@-R15
49                 STC.L     R4_BANK,@-R15
50                 STC.L     R3_BANK,@-R15
51                 STC.L     R2_BANK,@-R15
52                 STC.L     R1_BANK,@-R15
53                 STC.L     R0_BANK,@-R15
54             .endm
55
56             .macro POP_EXP_BASE_REG
57                 LDC.L     @R15+,R0_BANK
58                 LDC.L     @R15+,R1_BANK
59                 LDC.L     @R15+,R2_BANK

```

```

60         LDC.L      @R15+,R3_BANK
61         LDC.L      @R15+,R4_BANK
62         LDC.L      @R15+,R5_BANK
63         LDC.L      @R15+,R6_BANK
64         LDC.L      @R15+,R7_BANK
65         LDS.L      @R15+,FPSCR
66         LDS.L      @R15+,PR
67         LDC.L      @R15+,SPC
68         LDC.L      @R15+,SSR
69         .endm
70
71
72         ;;;;;;;;;;;;;;
73         ;          Reset_Handler
74         ;;;;;;;;;;;;;;
75         .section   RSTHandler,code
76  _Reset_Handler:
77         MOV.L      #BSC_INIT,R0
78         JMP        @R0
79         NOP
80  BSC_INIT_END:
81
82         MOV.L      #SDRAM_INIT,R0
83         JMP        @R0
84         NOP
85  SDRAM_INIT_END:
86
87         MOV.L      #EXPEVT,R0
88         MOV.L      @R0,R0
89         SHLR2     R0
90         SHLR      R0
91         MOV.L      #_RESET_VECTORS,R1
92         MOV.L      @(R0,R1),R0
93         JMP        @R0
94         NOP
95
96         .pool
97
98         ;;;;;;;;;;;;;;
99         ;          exceptional interrupt
100        ;;;;;;;;;;;;;;
101        .section   INTHandler,code
102        .export    _INTHandlerPRG
103
104  _INTHandlerPRG:
105        PUSH_EXP_BASE_REG
106
107        MOV.L      #EXPEVT,R0
108        MOV.L      @R0,R1
109
110        MOV.L      #_INT_VECTORS,R0
111        ADD        #-(H'40),R1
112        SHLR2     R1
113        SHLR      R1
114        MOV.L      @(R0,R1),R3
115
116        LDC.L      R3,SPC
117        MOV.L      #__INT_TERM,R0
118        LDS.L      R0,PR
119
120        RTE
121        NOP
122

```



```

123         .pool
124
125         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
126         ;           TLB miss interrupt
127         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
128         .org           H'300
129         _TLBmissHandler:
130
131         MOV.L          #(SP_STACK+H'200),R15
132         STC.L          SGR,@-R15
133
134         PUSH_EXP_BASE_REG
135
136         MOV.L          #EXPEVT,R0
137         MOV.L          @R0,R1
138         MOV.L          #_INT_VECTORS,R0
139         ADD            #-(H'40),R1
140         SHLR2          R1
141         SHLR           R1
142         MOV.L          @(R0,R1),R3
143
144         MOV.L          #_INT_MASK,R0
145         SHLR2          R1
146         MOV.B          @(R0,R1),R1
147         EXTU.B         R1,R1
148
149         STC            SR,R0
150         MOV.L          #(RBclr&IMASKclr),R2
151         AND            R2,R0
152         OR             R1,R0
153         LDC            R0,SSR
154
155         LDC.L          R3,SPC
156         MOV.L          #__TLBMISS_INT_TERM,R0
157         LDS.L          R0,PR
158
159         RTE
160         NOP
161
162         .align         4
163
164         __TLBMISS_INT_TERM:
165         MOV.L          #MDRBBLset,R0
166         LDC.L          R0,SR
167
168         PUSH_EXP_BASE_REG
169
170         LDC.L          @R15+,SGR
171         STC.L          SGR,R15
172         RTE
173         NOP
174
175         .pool
176
177         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
178         ;           IRQ
179         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
180         .org           H'500
181         _IRQ_Handler:
182         PUSH_EXP_BASE_REG
183
184         MOV.L          #INTEVT,R0
185         MOV.L          @R0,R1

```

```

186
187         MOV.L     #_INT_VECTORS,R0
188         ADD      #- (H'40),R1
189         SHLR2    R1
190         SHLR     R1
191         MOV.L     @(R0,R1),R3
192
193         MOV.L     #_INT_MASK,R0
194         SHLR2    R1
195         MOV.B     @(R0,R1),R1
196         EXTU.B   R1,R1
197
198         STC      SR,R0
199         MOV.L     #(RBBLclr&IMASKclr),R2
200         AND      R2,R0
201         OR       R1,R0
202         LDC      R0,SSR
203
204         LDC.L    R3,SPC
205         MOV.L     #__INT_TERM,R0
206         LDS.L    R0,PR
207
208         RTE
209         NOP
210
211         .align   4
212
213 __INT_TERM:
214         MOV.L     #MDRBBLset,R0
215         LDC.L    R0,SR
216
217         POP_EXP_BASE_REG
218
219         RTE
220         NOP
221
222         .pool
223
224 ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
225 ;           BSC_INIT
226 ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
227 BSC_INIT:
228         MOV.L     #H'FF801000,R0
229         MOV.L     #H'00000000,R1
230         MOV.L     R1,@R0
231         MOV.L     #H'FF801004,R0
232         MOV.L     R1,@R0
233         SYNCO
234
235         MOV.L     #H'FF802000,R0
236         MOV.L     #H'00000000,R1
237         MOV.L     R1,@R0
238         MOV.L     #H'FF802004,R0
239         MOV.L     #H'03333300,R1
240         MOV.L     R1,@R0
241         SYNCO
242
243         MOV.L     #H'FF802008,R0
244         MOV.L     #H'00000000,R1
245         MOV.L     R1,@R0
246         MOV.L     #H'FF80200C,R0
247         MOV.L     #H'0100000A,R1
248         MOV.L     R1,@R0

```

```

249         SYNCO
250
251         MOV.L         #H'FF802030,R0
252         MOV.L         #H'00000000,R1
253         MOV.L         R1,@R0
254         MOV.L         #H'FF802034,R0
255         MOV.L         #H'42424300,R1
256         MOV.L         R1,@R0
257         SYNCO
258
259         MOV.L         #H'FF802038,R0
260         MOV.L         #H'00000000,R1
261         MOV.L         R1,@R0
262         MOV.L         #H'FF80203C,R0
263         MOV.L         #H'02000008,R1
264         MOV.L         R1,@R0
265         SYNCO
266
267         MOV.L         #BSC_INIT_END,R0
268         JMP          @R0
269         NOP
270
271         .pool
272
273         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
274         ;                SDRAM INIT
275         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
276         SDRAM_INIT:
277         MOV.L         #H'FF800008,R0
278         MOV.L         #H'00000000,R1
279         MOV.L         R1,@R0
280         MOV.L         #H'FF80000C,R0
281         MOV.L         #H'034A0041,R1
282         MOV.L         R1,@R0
283         SYNCO
284
285         MOV.L         #H'FF800030,R0
286         MOV.L         #H'00000000,R1
287         MOV.L         R1,@R0
288         MOV.L         #H'FF800034,R0
289         MOV.L         #H'00000400,R1
290         MOV.L         R1,@R0
291         SYNCO
292
293         MOV.L         #H'FF800018,R0
294         MOV.L         #H'00000000,R1
295         MOV.L         R1,@R0
296         MOV.L         #H'FF80001C,R0
297         MOV.L         #H'00B80127,R1
298         MOV.L         R1,@R0
299         SYNCO
300
301         MOV.L         #H'FF800014,R0
302         MOV.L         #H'00000003,R1
303         MOV.L         R1,@R0
304         SYNCO
305
306         MOV.L         #H'00000002,R1
307         MOV.L         R1,@R0
308         SYNCO
309
310         MOV.L         R1,@R0
311         SYNCO

```

```

312
313         MOV.L     #H'00000004,R1
314         MOV.L     R1,@R0
315         SYNCO
316
317         MOV.L     R1,@R0
318         SYNCO
319
320         MOV.L     R1,@R0
321         SYNCO
322
323         MOV.L     R1,@R0
324         SYNCO
325
326         MOV.L     R1,@R0
327         SYNCO
328
329         MOV.L     R1,@R0
330         SYNCO
331
332         MOV.L     R1,@R0
333         SYNCO
334
335         MOV.L     R1,@R0
336         SYNCO
337
338         MOV.L     #H'FFA00198,R0
339         MOV.L     #H'00000000,R1
340         MOV.L     R1,@R0
341         SYNCO
342
343         MOV.L     #H'FF800008,R0
344         MOV.L     #H'00000000,R1
345         MOV.L     R1,@R0
346         MOV.L     #H'FF80000C,R0
347         MOV.L     #H'034A0241,R1
348         MOV.L     R1,@R0
349         SYNCO
350
351         MOV.L     #H'FF800014,R0
352         MOV.L     #H'00000001,R1
353         MOV.L     R1,@R0
354         SYNCO
355
356         MOV.L     #SDRAM_INIT_END,R0
357         JMP      @R0
358         NOP
359
360         .pool
361
362         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
363         ;          SPECIAL STACK(for TLBmiss Handler)
364         ;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;
365         .section   SP_S,data
366 SP_STACK:
367         .res.b    H'200
368
369         .END

```

### 3.2 Sample Program "vecttbl.src"

```

1  ;/*****"FILE COMMENT"*****/
2  ;*      System Name :   SH7764 Sample Program
3  ;*      File Name   :   vecttbl.src
4  ;*      Version    :   1.00.00
5  ;*      Contents   :   SH7764 Intialize Program
6  ;*      Model      :   Renesas SH7764 Board R0K507764E001BR
7  ;*      CPU        :   SH7764
8  ;*      Compiler   :   SHC.9.03.00
9  ;*      OS         :   none
10 ;*
11 ;*      note       :   < Caution >
12 ;*                  This sample program is provided simply as a reference and
13 ;*                  its operation is not guaranteed.
14 ;*                  Use this sample program as a technical reference when
15 ;*                  developing software.
16 ;*
17 ;*                  Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 ;*
19 ;*      History    :   2009/03/01 ver 1.00.00
20 ;*
21 ;*****/
22
23         .include   "vect.inc"
24
25         .section   VECTTBL,data
26         .export    _RESET_VECTORS
27
28 _RESET_VECTORS:
29         ;H'000      Power On Reset(Hitachi-UDI RESET)
30         .data.l    _PowerON_Reset
31
32         ;H'020      Manual Reset
33         .data.l    _Manual_Reset
34
35         ;H'040-120  Reserved
36         .datab.l   8,H'00000000
37
38         ;H'140 TLB Reset(DATA TLB Reset)
39         .data.l    _TLB_Reset
40
41         .section   INTTBL, data
42         .export    _INT_VECTORS
43
44 _INT_VECTORS:
45         ;H'040 Data TLB miss exception(read)
46         .data.l    _INT_TLB_MISS_READ_EXP
47
48         ;H'060 Data TLB miss exception(write)
49         .data.l    _INT_TLB_MISS_WRITE_EXP
50
51         ;H'080 Initial page write exception
52         .data.l    _INT_TLB_INIT_PAGE_EXP
53
54         ;H'0A0 Data TLB protection violation exception (read)
55         .data.l    _INT_TLB_PROTECT_READ_EXP
56
57         ;H'0C0 Data TLB protection violation exception (write)
58         .data.l    _INT_TLB_PROTECT_WRITE_EXP
59
60         ;H'0E0 Data address error(read)
61         .data.l    _INT_ADR_ERROR_READ

```

```

62
63         ;H'100 Data address error(write)
64         .data.l      _INT_ADR_ERROR_WRITE
65
66         ;H'120 FPU exception
67         .data.l      _INT_FPU_EXP
68
69         ;H'140 Instruction TLB multiple-hit exception
70         .data.l      _TLB_Reset
71
72         ;H'160 Unconditional trap(TRAPA)
73         .data.l      _INT_TRAP
74
75         ;H'180 General illegal instruction exception
76         .data.l      _INT_ILLEGAL_INST_EXP
77
78         ;H'1A0 Slot illegal instruction exception
79         .data.l      _INT_ILLEGAL_SLOT_EXP
80
81         ;===== EXTERNAL INTERRUPT =====
82         ;H'1C0 NMI
83         .data.l      _INT_NMI
84
85         ;H'1E0 USER_BREAK
86         .data.l      _INT_USER_BREAK
87
88         ;H'200 RESERVED
89         ;H'220 RESERVED
90         .datab.l     2,H'00000000
91
92         ;H'240 Interrupt IRQ0
93         .data.l      _INT_IRQ0
94
95         ;H'260 RESERVED
96         .data.l      H'00000000
97
98         ;H'280 Interrupt IRQ1
99         .data.l      _INT_IRQ1
100
101        ;H'2A0 to H'540 RESERVED
102        .datab.l     22,H'00000000
103
104        ;===== WDT =====
105        ;H'560 WDT interval timer interrupt
106        .data.l      _INT_WDT_ITI
107
108        ;===== TMU(ch0-ch2) =====
109        ;H'580 TMU ch-0 underflow interrupt
110        .data.l      _INT_TMU0_TUNI0
111
112        ;H'5A0 TMU ch-1 underflow interrupt
113        .data.l      _INT_TMU1_TUNI1
114
115        ;H'5C0 TMU ch-2 underflow interrupt
116        .data.l      _INT_TMU2_TNUI2
117
118        ;H'5E0 TMU ch-2 inputcapture interrupt
119        .data.l      _INT_TMU2_TICPI2
120
121        ;===== H-UDI =====
122        ;H'600 H-UDI interrupt
123        .data.l      _INT_H_UDII
124

```

```

125             ;===== LCDC =====
126             ;H'620 LCDC interrupt
127             .data.1      _INT_LCDC
128
129             ;===== DMAC(ch0-ch3) =====
130             ;H'640 ch-0 DMA transmit end or halfend interrupt
131             .data.1      _INT_DMAC_DMINT0
132
133             ;H'660 ch-1 DMA transmit end or halfend interrupt
134             .data.1      _INT_DMAC_DMINT1
135
136             ;H'680 ch-2 DMA transmit end or halfend interrupt
137             .data.1      _INT_DMAC_DMINT2
138
139             ;H'6A0 ch-3 DMA transmit end or halfend interrupt
140             .data.1      _INT_DMAC_DMINT3
141
142             ;H'6C0 ch0-5,ch6-11 DMA address error interrupt
143             .data.1      _INT_DMAC_DMAE
144
145             ;H'6E0 RESERVED
146             .data.1      H'00000000
147
148             ;===== SCIF(ch0) =====
149             ;H'700 SCIF ch-0 receive error interrupt
150             .data.1      _INT_SCIF0_ERI0

```

...Omitted

### 3.3 Sample Program "resetprg.c"

```

1  /*"FILE COMMENT"*****
2  *      System Name :   SH7764 Sample Program
3  *      File Name   :   resetprg.c
4  *      Version    :   1.00.00
5  *      Contents   :   SH7764 Intialize Program
6  *      Model      :   Renesas SH7764 Board R0K507764E001BR
7  *      CPU        :   SH7764
8  *      Compiler   :   SHC.9.03.00
9  *      OS         :   none
10 *
11 *      note       :   < Caution >
12 *                  This sample program is provided simply as a reference and
13 *                  its operation is not guaranteed.
14 *                  Use this sample program as a technical reference when
15 *                  developing software.
16 *
17 *                  Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 *
19 *      History    :   2009/03/01 ver 1.00.00
20 *
21 *****/
22
23
24 #include <machine.h>
25 #include <_h_c_lib.h>
26
27 #include "iodefine.h"
28 #include "stacksct.h"
29
30 static void Purge_OCBP(unsigned long *,unsigned long *);
31
32 #define SR_Default 0x700000F0          // MD/RB/BL Set, IMASK Level15
33 #define SR_Init 0x400000F0           // MD/RB/BL Clear, IMASK Level15
34 #ifdef _FPD // when -fpu=double is specified
35 #define FPSCR_Init 0x000C0001
36 #else
37 #define FPSCR_Init 0x00040001
38 #endif
39 #define INT_OFFSET 0x100UL
40
41 #define RAMCR_ADDRESS      0xff000074
42 #define RAMCR_INIT_VALUE  0x00000200
43
44 #ifdef __cplusplus
45 extern "C" {
46 #endif
47 extern void INTHandlerPRG(void);
48 void PowerON_Reset(void);
49 void Manual_Reset(void);
50 void main(void);
51 #ifdef __cplusplus
52 }
53 #endif
54
55 #ifdef __cplusplus // Use Hardware Setup
56 extern "C" {
57 #endif
58 extern void HardwareSetup(void);
59 #ifdef __cplusplus
60 }
61 #endif

```



```

62
63 #pragma section _ResetPRG
64 #pragma entry PowerON_Reset
65
66 void PowerON_Reset(void)
67 {
68     _UDWORD* ramcr_address;
69
70     /* ===== FPU Setup ===== */
71     set_fpscr(FPSCR_Init);
72
73     /* ===== IMASK Set ===== */
74     set_imask(15);           // IMASK Level15
75
76     /* ===== Module Setup Function ===== */
77     HardwareSetup();        // Use Hardware Setup
78
79     /* ===== B D Section Initial ===== */
80     _INITSCT();
81
82     Purge_OCBP(__sectop("B"),__secend("B"));  /* Purge Bsection */
83     Purge_OCBP(__sectop("R"),__secend("R"));  /* Purge Rsection */
84
85     /*===== VBR Setup ===== */
86     set_vbr((void *)((_UINT)INTHandlerPRG - INT_OFFSET));
87
88
89     // _CALL_INIT();           // Remove the comment when you use global class object
90
91     // _INIT_IOLIB();         // Enable I/O in the application(both SIM I/O and hardware I/O)
92
93     CACHE.RAMCR = RAMCR_INIT_VALUE;
94
95     /* ===== SR Init ===== */
96     set_cr(SR_Init);
97
98     /* ===== IMASK Set ===== */
99     // set_imask(0);           // IMASK Level0
100
101     /* ===== Main Function ===== */
102     main();
103
104     // _CLOSEALL();           // Close I/O in the application(both SIM I/O and hardware I/O)
105
106     // _CALL_END();           // Remove the comment when you use global class object
107
108     sleep();
109 }
110
111 void Manual_Reset(void)
112 {
113 }
114
115 static void Purge_OCBP(unsigned long *start, unsigned long *end)
116 {
117     long addr_length;
118     unsigned long *start1;
119
120     addr_length = (unsigned long)end - (unsigned long)start;
121
122     start1 = start +8;
123
124     /* If purge cache is bigger than 4 entry,then use OCBP_LOOP_1*/

```

```

125     if(addr_length > 32)          /* OCBP_LOOP_1 */
126     {
127         do{
128             ocbp(start);
129             start += 16;
130             ocbp(start1);
131             start1 += 16;
132         }while(start1 < (end + 8));
133     }
134     else                          /* OCBP_LOOP_2 */
135     {
136         while(start < end)
137         {
138             ocbp(start);
139             start = start + 8;
140         }
141     }
142 }

```

### 3.4 Sample Program "hwsetup.c"

```

1  /*"FILE COMMENT"*****
2  *      System Name :   SH7764 Sample Program
3  *      File Name   :   hwsetup.c
4  *      Version    :   1.00.00
5  *      Contents   :   SH7764 Intialize Program
6  *      Model      :   Renesas SH7764 Board R0K507764E001BR
7  *      CPU        :   SH7764
8  *      Compiler   :   SHC.9.03.00
9  *      OS         :   none
10 *
11 *      note       :   < Caution >
12 *                  This sample program is provided simply as a reference and
13 *                  its operation is not guaranteed.
14 *                  Use this sample program as a technical reference when
15 *                  developing software.
16 *
17 *                  Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 *
19 *      History    :   2009/03/01 ver 1.00.00
20 *
21 *****/
22
23
24 #include <machine.h>
25 #include "iodefine.h"
26 #ifdef __cplusplus
27 extern "C" {
28 #endif
29 extern void HardwareSetup(void);
30 #ifdef __cplusplus
31 }
32 #endif
33
34 void cache_setup(void);
35 void gpio_initial(void);
36
37 #define  CCR_VALUE  0x00000105 /* cashe copy back mode   */
38
39 void HardwareSetup(void)
40 {
41     /* ===== Cache Setup ===== */
42     cache_setup();
43
44     /* ===== GPIO Initial ===== */
45     gpio_initial();
46 }
47
48 void cache_setup(void)
49 {
50     CACHE.CCR = (CCR_VALUE | 0x00000808);
51     icbi((void *)cache_setup);
52 }
53
54 void gpio_initial(void)
55 {
56 #if 0
57     /* ----- IRQ Select ----- */
58     GPIO.PTSEL_K.BIT._PTSEL_K7 = 1; // IRQ1
59     GPIO.PTSEL_S.BIT._PTSEL_S15 = 0; // IRQ0
60
61     /* ----- ATAPI Select ----- */

```

```

62     GPIO.PTSEL_R.WORD = 0xffff;
63     GPIO.PTSEL_S.WORD |= 0x3ffe;
64
65     /* ----- SCIF0 Select ----- */
66     GPIO.PTSEL_K.BIT._PTSEL_K6 = 0; // SCK0
67     GPIO.PTSEL_P.BIT._PTSEL_P11 = 0; // RXD0
68     GPIO.PTSEL_P.BIT._PTSEL_P10 = 0; // TXD0
69
70     /* ----- FLCTL Select ----- */
71     GPIO.PTSEL_A.BIT._PTSEL_A5 = 0; // FCE
72     GPIO.PTSEL_A.BIT._PTSEL_A4 = 0; // FRE
73     GPIO.PTSEL_A.BIT._PTSEL_A3 = 0; // FWE
74     GPIO.PTSEL_C.BIT._PTSEL_C0 = 0; // FALE
75     GPIO.PTSEL_K.BIT._PTSEL_K6 = 2; // FCLE
76     GPIO.PTSEL_K.BIT._PTSEL_K5 = 1; // FR/B
77
78     #if 1 // VDC2 Select
79     /* ----- VDC2 Select ----- */
80     GPIO.PTSEL_G.WORD = 0x5555;
81     GPIO.PTSEL_H.BIT._PTSEL_H3 = 1; // DE_V
82     GPIO.PTSEL_H.BIT._PTSEL_H2 = 1; // DCLKOUT
83     GPIO.PTSEL_H.BIT._PTSEL_H1 = 1; // DR4
84     GPIO.PTSEL_H.BIT._PTSEL_H0 = 1; // DR5
85     GPIO.PTSEL_I.BIT._PTSEL_I7 = 1; // DB3
86     GPIO.PTSEL_I.BIT._PTSEL_I6 = 1; // DB2
87     GPIO.PTSEL_I.BIT._PTSEL_I5 = 1; // DB1
88     GPIO.PTSEL_I.BIT._PTSEL_I4 = 1; // DG1
89     GPIO.PTSEL_I.BIT._PTSEL_I3 = 1; // DG0
90     GPIO.PTSEL_I.BIT._PTSEL_I2 = 1; // DB5
91     GPIO.PTSEL_I.BIT._PTSEL_I1 = 1; // DB4
92     GPIO.PTSEL_I.BIT._PTSEL_I0 = 1; // COM/CDE
93     GPIO.PTSEL_K.BIT._PTSEL_K4 = 1; // DB0
94     GPIO.PTSEL_K.BIT._PTSEL_K3 = 1; // HSYNC
95     GPIO.PTSEL_K.BIT._PTSEL_K2 = 1; // DCLKIN
96     GPIO.PTSEL_K.BIT._PTSEL_K1 = 1; // VSYNC
97     GPIO.PTSEL_K.BIT._PTSEL_K0 = 1; // DE_C/DE_H
98     #else
99     /* ----- LCDC Select ----- */
100    GPIO.PTSEL_G.WORD = 0x0000;
101    GPIO.PTSEL_H.WORD &= ~(0x00ff);
102    GPIO.PTSEL_I.WORD &= ~(0xffff);
103    GPIO.PTSEL_K.WORD &= ~(0x03ff);
104    #endif
105
106    /* ----- ETHER Select ----- */
107    GPIO.PTSEL_D.WORD = 0x0000;
108    GPIO.PTSEL_E.WORD = 0x0000;
109    GPIO.PTSEL_F.BIT._PTSEL_F4 = 0; // EXOUT
110    GPIO.PTSEL_F.BIT._PTSEL_F3 = 0; // LNKSTA
111    GPIO.PTSEL_F.BIT._PTSEL_F2 = 0; // WOL
112    GPIO.PTSEL_F.BIT._PTSEL_F1 = 0; // MDIO
113    GPIO.PTSEL_F.BIT._PTSEL_F0 = 0; // MDC

```

...Omitted

### 3.5 Sample Program "stacksct.h"

```

1  /*"FILE COMMENT"*****
2  *      System Name :   SH7764 Sample Program
3  *      File Name   :   stacksct.h
4  *      Version    :   1.00.00
5  *      Contents   :   SH7764 Intialize Program
6  *      Model      :   Renesas SH7764 Board R0K507764E001BR
7  *      CPU        :   SH7764
8  *      Compiler   :   SHC.9.03.00
9  *      OS         :   none
10 *
11 *      note       :   < Caution >
12 *                  This sample program is provided simply as a reference and
13 *                  its operation is not guaranteed.
14 *                  Use this sample program as a technical reference when
15 *                  developing software.
16 *
17 *                  Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 *
19 *      History    :   2009/03/01 ver 1.00.00
20 *
21 *****/
22 #pragma stacksize 0x400          /* Do not modify this line. */

```

### 3.6 Sample Program "dbsct.c"

```

1  /*"FILE COMMENT"*****
2  *      System Name :   SH7764 Sample Program
3  *      File Name   :   dbsct.c
4  *      Version    :   1.00.00
5  *      Contents   :   SH7764 Intialize Program
6  *      Model      :   Renesas SH7764 Board R0K507764E001BR
7  *      CPU        :   SH7764
8  *      Compiler   :   SHC.9.03.00
9  *      OS         :   none
10 *
11 *      note       :   < Caution >
12 *                  This sample program is provided simply as a reference and
13 *                  its operation is not guaranteed.
14 *                  Use this sample program as a technical reference when
15 *                  developing software.
16 *
17 *                  Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 *
19 *      History    :   2009/03/01 ver 1.00.00
20 *
21 *****/
22
23
24 #include "typedefine.h"
25
26 #pragma section $DSEC
27 static const struct {
28     _UBYTE *rom_s;      /* ROM top address of Initialize data section */
29     _UBYTE *rom_e;      /* ROM end address of Initialize data section */
30     _UBYTE *ram_s;      /* RAM top address of Initialize data section */
31 } DTBL[] = {
32     { __sectop("D"), __secend("D"), __sectop("R") }
33 };
34 #pragma section $BSEC
35 static const struct {
36     _UBYTE *b_s;        /* top address of no Initialize data section */
37     _UBYTE *b_e;        /* end address of no Initialize data section */
38 } BTBL[] = {
39     { __sectop("B"), __secend("B") }
40 };

```

### 3.7 Sample Program "main.c"

```

1  /*"FILE COMMENT"*****
2  *      System Name :   SH7764 Sample Program
3  *      File Name   :   sh7764.c
4  *      Version    :   1.00.00
5  *      Contents   :   SH7764 Intialize Program
6  *      Model      :   Renesas SH7764 Board R0K507764E001BR
7  *      CPU        :   SH7764
8  *      Compiler   :   SHC.9.03.00
9  *      OS         :   none
10 *
11 *      note       :   < Caution >
12 *                  This sample program is provided simply as a reference and
13 *                  its operation is not guaranteed.
14 *                  Use this sample program as a technical reference when
15 *                  developing software.
16 *
17 *                  Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 *
19 *      History    :   2009/03/01 ver 1.00.00
20 *
21 *****/
22
23
24 // #include "typedefine.h"
25 #ifdef __cplusplus
26 // #include <ios> // Remove the comment when you use ios
27 // _SINT ios_base::Init::init_cnt; // Remove the comment when you use ios
28 #endif
29
30 void main(void);
31 #ifdef __cplusplus
32 extern "C" {
33 void abort(void);
34 }
35 #endif
36
37 void main(void)
38 {
39 }
40
41 #ifdef __cplusplus
42 void abort(void)
43 {
44 }
45 }
46 #endif

```

### 3.8 Sample Program "intprg.c"

```

1  /*"FILE COMMENT"*****
2  *      System Name :   SH7764 Sample Program
3  *      File Name   :   intprg.c
4  *      Version    :   1.00.00
5  *      Contents   :   SH7764 Intialize Program
6  *      Model      :   Renesas SH7764 Board R0K507764E001BR
7  *      CPU        :   SH7764
8  *      Compiler   :   SHC.9.03.00
9  *      OS         :   none
10 *
11 *      note       :   < Caution >
12 *                  This sample program is provided simply as a reference and
13 *                  its operation is not guaranteed.
14 *                  Use this sample program as a technical reference when
15 *                  developing software.
16 *
17 *                  Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 *
19 *      History    :   2009/03/01 ver 1.00.00
20 *
21 *****/
22
23
24 #include <machine.h>
25 #include "iodefine.h"
26
27 #pragma section _IntPRG
28
29 //;H'040 Data TLB miss exception(read)
30 void INT_TLB_MISS_READ_EXP(void)
31 {
32     /* sleep(); */
33 }
34
35 //;H'060 Data TLB miss exception(write)
36 void INT_TLB_MISS_WRITE_EXP(void)
37 {
38     /* sleep(); */
39 }
40
41 //;H'080 Initial page write exception
42 void INT_TLB_INIT_PAGE_EXP(void)
43 {
44     /* sleep(); */
45 }
46
47 //;H'0A0 Data TLB protection violation exception (read)
48 void INT_TLB_PROTECT_READ_EXP(void)
49 {
50     /* sleep(); */
51 }

```

...Omitted



### 3.9 Sample Program "vect.inc"

```

1  ;*"FILE COMMENT"*****
2  ;   System Name :   SH7764 Sample Program
3  ;   File Name   :   vect.inc
4  ;   Version    :   1.00.00
5  ;   Contents   :   SH7764 Intialize Program
6  ;   Model      :   Renesas SH7764 Board R0K507764E001BR
7  ;   CPU        :   SH7764
8  ;   Compiler   :   SHC.9.1.00
9  ;   OS         :   none
10 ;
11 ;   note       :   < Caution >
12 ;               This sample program is provided simply as a reference and
13 ;               its operation is not guaranteed.
14 ;               Use this sample program as a technical reference when
15 ;               developing software.
16 ;
17 ;   Copyright (C) 2009 Renesas Technology Corp. All Rights Reserved
18 ;
19 ;   History    :   2009/03/01 ver 1.00.00
20 ;
21 ;*****/
22 ;<<VECTOR DATA START (POWER ON RESET)>>
23 ;H'000 Power On Reset(H-UDI RESET)
24 .import      _PowerON_Reset
25 ;<<VECTOR DATA END (POWER ON RESET)>>
26
27 ;<< VECTOR DATA START (MANUAL RESET) >>
28 ;H'020 Manual Reset (Dummy)
29 .import      _Manual_Reset
30 ;<<VECTOR DATA END (MANUAL RESET)>>
31
32 ; H'040      Data TLB miss exception(read)
33 .import      _INT_TLB_MISS_READ_EXP
34
35 ; H'060      Data TLB miss exception(write)
36 .import      _INT_TLB_MISS_WRITE_EXP
37
38 ;H'080      Initial page write exception
39 .import      _INT_TLB_INIT_PAGE_EXP
40
41 ;H'0A0      Data TLB protection violation exception (read)
42 .import      _INT_TLB_PROTECT_READ_EXP
43
44 ;H'0C0 Data TLB protection violation exception (write)
45 .import      _INT_TLB_PROTECT_WRITE_EXP
46
47 ;H'0E0 Data address error(read)
48 .import      _INT_ADR_ERROR_READ
49
50 ;H'100 Data address error(write)
51 .import      _INT_ADR_ERROR_WRITE
52
53 ;H'120 FPU exception
54 .import      _INT_FPU_EXP

```

...Omitted

#### 4. Documents for Reference

- Hardware Manual  
SH7764 Group Hardware Manual (REJ09B0360)  
The most up-to-date version of this document is available on the Renesas Technology Website.
- Software Manual (REJ09B0003)  
SH-4A Software Manual  
The most up-to-date version of this document is available on the Renesas Technology Website.

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		Page	Summary
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